## 1.8 V/2.5 V Differential 2 x 2 **Crosspoint Switch with CML Outputs Clock/Data Buffer/Translator**

Multi-Level Inputs w/ Internal Termination

# NB7V72M

### Description

The NB7V72M is a high bandwidth, low voltage, fully differential 2 x 2 crosspoint switch with CML outputs. The NB7V72M design is optimized for low skew and minimal jitter as it produces two identical copies of Clock or Data operating up to 5 GHz or 6.5 Gb/s, respectively. As such, the NB7V72M is ideal for SONET, GigE, Fiber Channel, Backplane and other clock/data distribution applications. The differential IN/IN inputs incorporate internal 50  $\Omega$  termination resistors and will accept LVPECL, CML, or LVDS logic levels (see Figure 10). The 16 mA differential CML outputs provide matching internal 50  $\Omega$  terminations and produce 400 mV output swings when externally terminated with a 50  $\Omega$  resistor to V<sub>CC</sub> (see Figure 11). The NB7V72M is the 1.8 V/2.5 V CML version of the NB7L72M and is offered in a low profile 3x3 mm 16-pin QFN package. Application notes, models, and support documentation are available at www.onsemi.com.

The NB7V72M is a member of the GigaComm<sup>™</sup> family of high performance clock products.

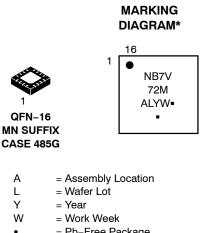
#### Features

- Maximum Input Data Rate > 6.5 Gb/s
- Data Dependent Jitter < 15 ps pk-pk
- Maximum Input Clock Frequency > 5 GHz
- Random Clock Jitter < 0.8 ps RMS, Max
- 150 ps Typical Propagation Delay
- 30ps Typical Rise and Fall Times
- Differential CML Outputs, 400 mV peak-to-peak, typical
- Operating Range:  $V_{CC} = 1.71$  V to 2.625 V with GND = 0 V
- Internal 50  $\Omega$  Input Termination Resistors
- QFN-16 Package, 3mm x 3mm
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



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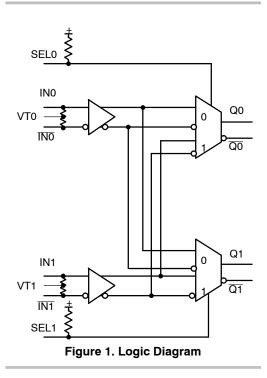
www.onsemi.com



= Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.



#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

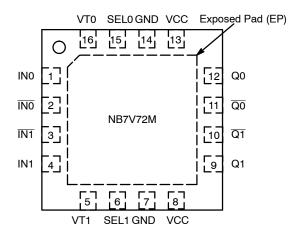


Figure 2. Pin Configuration (Top View)

### **Table 2. PIN DESCRIPTION**

#### Table 1. INPUT/OUTPUT SELECT TRUTH TABLE

SEL0*	SEL1*	Q0	Q1
L	L	INO	INO
L	Н	IN0	IN1
Н	L	IN1	INO
Н	Н	IN1	IN1

\*Defaults HIGH when left open

Pin	Name	I/O	Description
1	IN0	LVPECL, CML, LVDS Input	Noninverted Differential Input. (Note 1)
2	INO	LVPECL, CML, LVDS Input	Inverted Differential Input. (Note 1)
3	ĪN1	LVPECL, CML, LVDS Input	Inverted Differential Input. (Note 1)
4	IN1	LVPECL, CML, LVDS Input	Noninverted Differential Input. (Note 1)
5	VT1	-	Internal 50 $\Omega$ Termination Pin for IN1 and $\overline{\text{IN1}}$
6	SEL1	LVCMOS Input	Input Select logic pin for IN0 or IN1 Inputs to Q1 output. See Table 1, Input/Output Select Truth Table; pin defaults HIGH when left open.
7	GND		Negative Supply Voltage
8	VCC	-	Positive Supply Voltage
9	Q1	CML Output	Noninverted Differential Output. (Note 1)
10	Q1	CML Output	Inverted Differential Output. (Note 1)
11	<u>Q0</u>	CML Output	Inverted Differential Output. (Note 1)
12	Q0	CML Output	Noninverted Differential Output. (Note 1)
13	VCC	-	Positive Supply Voltage
14	GND	-	Negative Supply Voltage
15	SEL0	LVCMOS Input	Input Select logic pin for IN0 or IN1 Inputs to Q0 output. See Table 1, Input/Output Select Truth Table; pin defaults HIGH when left open.
16	VT0	-	Internal 50 $\Omega$ Termination Pin for IN0 and $\overline{\rm IN0}$
-	EP	-	The Exposed Pad (EP) on the QFN-16 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and is recommended to be electrically and thermally connected to GND on the PC board.

1. In the differential configuration when the input termination pins (VT0, VT1) are connected to a common termination voltage or left open, and if no signal is applied on INx/INx input, then the device will be susceptible to self-oscillation. 2. All VCC and GND pins must be externally connected to a power supply for proper operation.

#### **Table 3. ATTRIBUTES**

Characteristics	Value
ESD Protection Human Body Model Machine Model	> 4 kV > 200 V
R <sub>PU</sub> – Input Pullup Resistor	75 kΩ
Moisture Sensitivity 16–QFN	Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in
Transistor Count	210
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	•

For additional information, see Application Note AND8003/D.

#### **Table 4. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	Positive Power Supply	GND = 0 V		3.0	V
V <sub>IN</sub>	Positive Input Voltage	GND = 0 V		–0.5 to V <sub>CC</sub> +0.5	V
V <sub>INPP</sub>	Differential Input Voltage  IN - IN			1.89	V
I <sub>IN</sub>	Input Current Through $R_T$ (50 $\Omega$ Resistor)			±40	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient) (Note 3)	0 lfpm 500 lfpm	QFN-16 QFN-16	42 35	°C/W °C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case) (Note 3)		QFN-16	4	°C/W
T <sub>sol</sub>	Wave Solder Pb-Free			265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

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Symbol	Characteristic	Min	Тур	Max	Unit
POWER	SUPPLY CURRENT				
I <sub>CC</sub>	Power Supply Current (Inputs and Outputs Open) $V_{CC} = 2$ . $V_{CC} = 1$ .	5 V 120 8 V 80	145 110	170 140	mA
CML OUT	PUTS			_	
V <sub>OH</sub>	Output HIGH Voltage (Note 5) $ V_{CC} = 2. \\ V_{CC} = 1. $	5 V 2460 8 V 1760	V <sub>CC</sub> – 20 2480 1780	V <sub>CC</sub> 2500 1800	mV
V <sub>OL</sub>	Output LOW Voltage (Note 5) $ V_{CC} = 2. \\ V_{CC} = 1. $	V <sub>CC</sub> – 650 5 V 1850 8 V 1150	V <sub>CC</sub> - 400 2100 1400	V <sub>CC</sub> - 300 2200 1500	mV
DIFFERE	NTIAL CLOCK INPUTS DRIVEN SINGLE-ENDED (Note 6) (F	igures 5 and 7)		•	
V <sub>th</sub>	Input Threshold Reference Voltage Range (Note 7)	1050		V <sub>CC</sub> – 100	mV
V <sub>IH</sub>	Single-Ended Input HIGH Voltage	V <sub>th</sub> + 100		V <sub>CC</sub>	mV
V <sub>IL</sub>	Single-Ended Input LOW Voltage	GND		V <sub>th</sub> – 100	mV
V <sub>ISE</sub>	Single-Ended Input Voltage (VIH - VIL)	200		V <sub>CC</sub> – GND	mV
DIFFERE	NTIAL DATA/CLOCK INPUTS DRIVEN DIFFERENTIALLY (Fi	gures 6 and 8) (Note	8)		
V <sub>IHD</sub>	Differential Input HIGH Voltage (INn, INn)	1100		V <sub>CC</sub>	mV
V <sub>ILD</sub>	Differential Input LOW Voltage (INn, INn)	GND		V <sub>CC</sub> – 100	mV
$V_{\text{ID}}$	Differential Input Voltage (INn, ĪNn) (V <sub>IHD</sub> - V <sub>ILD</sub> )	100		1200	mV
V <sub>CMR</sub>	Input Common Mode Range (Differential Configuration, Note 9 (Figure 9)	9) 1050		V <sub>CC</sub> – 50	mV
IIH	Input HIGH Current INn, INn (VTIN/VTIN Open)	-150		150	μA
Ι <sub>ΙL</sub>	Input LOW Current INn, INn (VTIN/VTIN Open)	-150		150	μA
CONTRO	LINPUTS (SEL0, SEL1)				
$V_{\text{IH}}$	Input HIGH Voltage for Control Pins	V <sub>CC</sub> x 0.65		V <sub>CC</sub>	mV
$V_{\text{IL}}$	Input LOW Voltage for Control Pins	GND		V <sub>CC</sub> x 0.35	mV
I <sub>IH</sub>	Input HIGH Current	-150	20	150	μA
Ι <sub>ΙL</sub>	Input LOW Current	-150	5	150	μA
TERMINA	TION RESISTORS				
R <sub>TIN</sub>	Internal Input Termination Resistor	40	50	60	Ω
R <sub>TOUT</sub>	Internal Output Termination Resistor	40	50	60	Ω

Device will meet the specifications after thermal equilibrium has b een established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

Input and output parameters vary 1:1 with V<sub>CC</sub>.
 CML outputs loaded with 50 Ω to V<sub>CC</sub> for proper operation.
 V<sub>th</sub>, V<sub>IH</sub>, V<sub>IL</sub>, and V<sub>ISE</sub> parameters must be complied with simultaneously.
 V<sub>th</sub> is applied to the complementary input when operating in single-ended mode.
 V<sub>IHD</sub>, V<sub>ILD</sub>, V<sub>ID</sub>, and V<sub>CMR</sub> parameters must be complied with simultaneously.
 V<sub>CMR</sub> min varies 1:1 with GND, V<sub>CMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>CMR</sub> range is referenced to the most positive side of the differential input signal.

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Symbol	Characteristic		Min	Тур	Max	Unit
f <sub>MAX</sub>	Maximum Input Clock Frequency V <sub>CC</sub> V <sub>CC</sub>	= 2.5 V = 1.8 V	5 4.5			GHz
f <sub>DATAMAX</sub>	Maximum Operating Data Rate (PRBS23)		6.5			Gbps
V <sub>OUTPP</sub>	Output Voltage Amplitude (@ $V_{INPPmin}$ ) fin $\leq$ 5 GHz (See Figures 3 and 10, Note 11)		200	400		mV
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay to Differential Outputs, @ 1GHz, Measured at Differential Cross-point	INn/INn to Qn/Qn	110	150	200	ps
t <sub>PLH</sub> TC	Propagation Delay Temperature Coefficient			50		∆fs/°C
t <sub>SKEW</sub>	Output-to-Output Skew (within device) (Note 12) Device-to-Device Skew (t <sub>pdmax</sub> - t <sub>pdmin</sub> )				30 50	ps
t <sub>DC</sub>	Output Clock Duty Cycle (Reference Duty Cycle = 50%) ${\rm f}_{\rm in} \leq 5 GHz$		45	50	55	%
t <sub>jitter</sub>	RJ – Output Random Jitter (Note 13) fin $\leq$ 5 GHz DJ – Deterministic Jitter (Note 14) $\leq$ 9 Gbps			0.5	0.8 10	ps RMS ps pk–pk
V <sub>INPP</sub>	Input Voltage Swing (Differential Configuration) (Note 15)		100		1200	mV
t <sub>r,</sub> , t <sub>f</sub>	Output Rise/Fall Times @ 1 GHz (20% - 80%), Qn, Qn		20	30	50	ps

#### Table 6. AC CHARACTERISTICS V<sub>CC</sub> = 1.71 V to 2.625 V, GND = 0 V, T<sub>A</sub> = $-40^{\circ}$ C to $85^{\circ}$ C (Note 10)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

10. Measured using a 400 mV source, 50% duty cycle clock source. All output loading with external 50  $\Omega$  to V<sub>CC</sub>. Input edge rates  $\geq$  40 ps (20% - 80%).

11. Output voltage swing is a single-ended measurement operating in differential mode.

12. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from cross-point of the inputs to the cross-point of the outputs.

13. Additive RMS jitter with 50% duty cycle clock signal.

14. Additive Peak-to-Peak data dependent jitter with input NRZ data at PRBS23.

15. Input voltage swing is a single-ended measurement operating in differential mode.

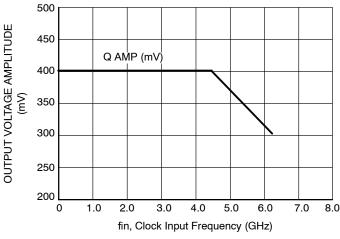


Figure 3. CLOCK Output Voltage Amplitude ( $V_{OUTPP}$ ) vs. Input Frequency ( $f_{in}$ ) at Ambient Temperature (Typ)

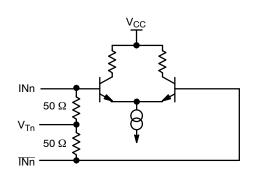
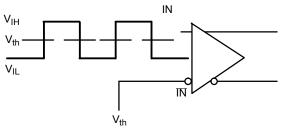
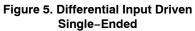
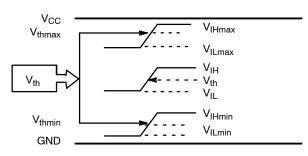


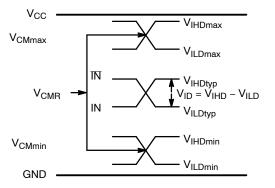
Figure 4. Input Structure



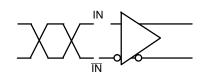




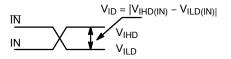




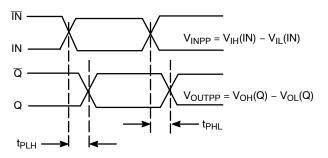














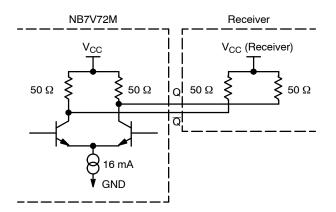


Figure 11. Typical CML Output Structure and Termination

## NB7V72M

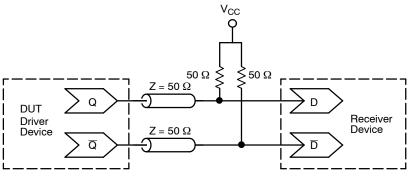
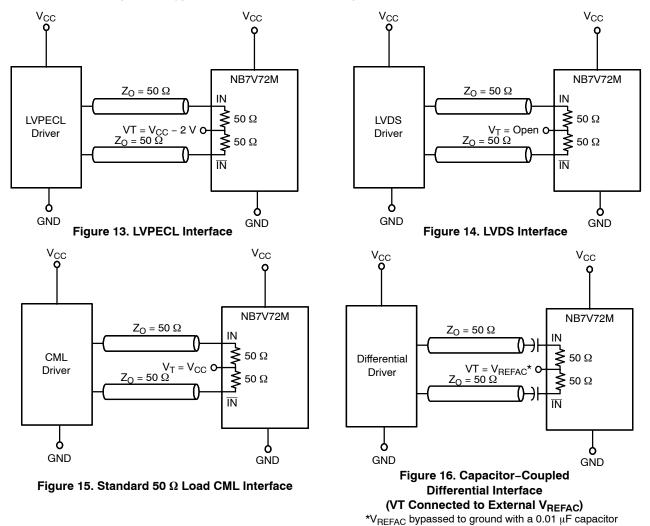


Figure 12. Typical Termination for CML Output Driver and Device Evaluation



#### **ORDERING INFORMATION**

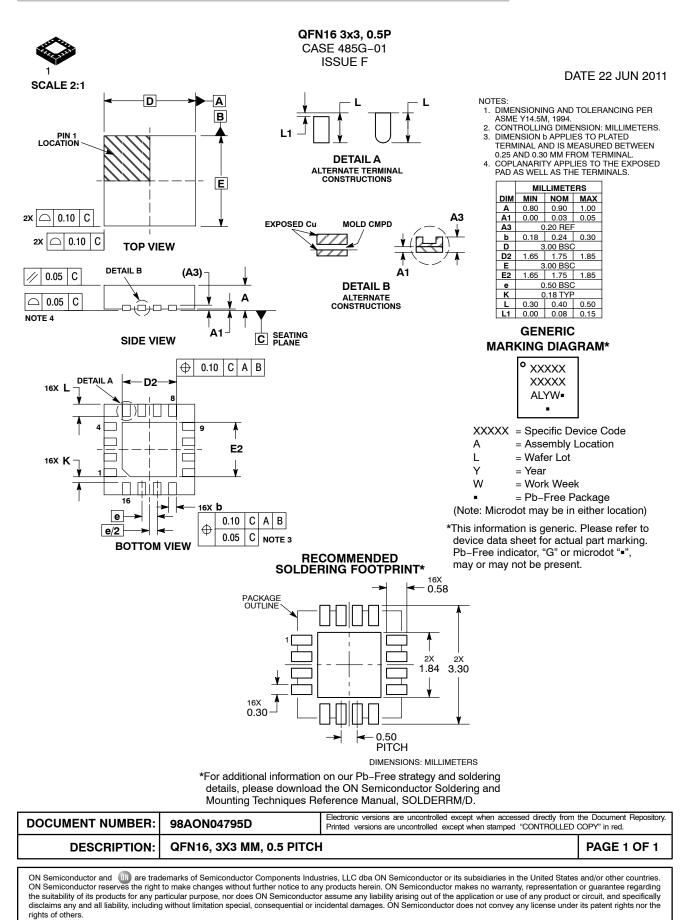
Device	Package	Shipping <sup>†</sup>
NB7V72MMNHTBG	QFN-16 (Pb-free)	100 / Tape & Reel
NB7V72MMNTXG	QFN-16 (Pb-free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

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